Sirenza Microdevices' SDM-09060-B1F 65W power module is a robust impedance matched, single-stage, push-pull Class AB amplifier module suitable for use as a power amplifier driver or output stage. The power transistors are fabricated using Sirenza's latest, high performance LDMOS process. It is a drop-in, no-tune solution for high power applications requiring high efficiency, excellent linearity, and unit-tounit repeatability. It is internally matched to 50 ohms.

Functional Block Diagram

Case Flange = Ground

## SDM-09060-B1F SDM-09060-B1FY

RoHS Compliant \& Green Package

## 925-960 MHz Class AB <br> 65W Power Amplifier Module



## Product Features

- Available in RoHS compliant packaging
- $50 \Omega$ RF impedance
- 65W Output $\mathrm{P}_{1 \mathrm{~dB}}$
- Single Supply Operation : Nominally 28V
- High Gain: 17 dB at 942 MHz
- High Efficiency : 44\% at 942 MHz
- ESD Protection: JEDEC Class 2 (2000V HBM)

Applications

- Base Station PA driver
- Repeater
- CDMA
- GSM / EDGE


## Key Specifications

| Symbol | Parameter | Units | Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency | Frequency of Operation | MHz | 925 | - | 960 |
| $\mathrm{P}_{1 \mathrm{~dB}}$ | Output Power at 1dB Compression, 943 MHz | W | 60 | 65 | - |
| Gain | Gain at 60W PEP, 942MHz and 943MHz | dB | 16 | 17 | - |
| Gain Flatness | Peak-to-Peak Gain Variation, 60W PEP, 925-960MHz | dB | - | 0.3 | 0.5 |
| Efficiency | Drain Efficiency at 60W PEP, 942MHz and 943MHz | \% | 32 | 34 | - |
| Efficiency | Drain Efficiency at 60W CW, 942MHz | \% |  | 44 | - |
| IRL | Input Return Loss 60W PEP Output Power, 925-960MHz | dB | - | -15 | -12 |
| IMD | 3rd Order IMD Product, 60W PEP, 942MHz and 943MHz | dBc | - | -31 | -27 |
| Delay | Signal Delay from Pin 3 to Pin 8 | nS | - | 4.0 | - |
| Phase Linearity | Deviation from Linear Phase (Peak-to-Peak) | Deg | - | 0.5 | - |
| $\mathrm{R}_{\text {TH }}$ | Thermal Resistance (Junction to Case) | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  | 1.5 |  |
| Test Conditions $Z_{\text {in }}=Z_{\text {out }}=50 \Omega, \mathrm{~V}_{\mathrm{DD}}=28.0 \mathrm{~V}, \mathrm{I}_{\mathrm{DQ1}}=\mathrm{I}_{\mathrm{DQ} 2}=300 \mathrm{~mA} . \mathrm{T}_{\text {Flange }}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |

## Quality Specifications

| Parameter | Description | Unit | Typical |
| :---: | :--- | :---: | :---: |
| ESD Rating | Human Body Model | Volts | 2000 |
| MTTF | $200^{\circ} \mathrm{C}$ Channel | Hours | $1.2 \times 10^{6}$ |

## Pin Description

| Pin \# | Function | Description |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {GS1 }}$ | LDMOS FET Q1 gate bias. $\mathrm{V}_{\text {GSTH }} 3.0$ to 5.0 VDC. See Notes 2, 3 and 4 |
| 2,4,7,9 | Ground | Module Topside ground. |
| 3 | RF Input | Module RF input. This pin is internally connected to DC ground. Do not apply DC voltages to the RF leads. Care must be taken to protect against video transients that may damage the active devices. |
| 5 | $\mathrm{V}_{\text {GS2 }}$ | LDMOS FET Q2 gate bias. $\mathrm{V}_{\text {GSTH }} 3.0$ to 5.0 VDC. See Notes 2, 3 and 4 |
| 6 | $\mathrm{V}_{\mathrm{D} 2}$ | LDMOS FET Q2 drain bias. See Note 1. |
| 8 | RF Output | Module RF output. This pin is internally connected to DC ground. Do not apply DC voltages to the RF leads. Care must be taken to protect against video transients that may damage the active devices. |
| 10 | $\mathrm{V}_{\mathrm{D} 1}$ | LDMOS FET Q1 drain bias. See Note 1. |
| Flange | Ground | Baseplate provides electrical ground and a thermal transfer path for the device. Proper mounting assures optimal performance and the highest reliability. See Sirenza applications note AN-054 Detailed Installation Instructions for Power Modules. |

## Simplified Device Schematic



## Absolute Maximum Ratings

| Parameters | Value | Unit |
| :--- | :---: | :---: |
| Drain Voltage (VD) | 35 | V |
| RF Input Power | +37 | dBm |
| Load Impedance for Continuous Operation Without <br> Damage | $5: 1$ | VSWR |
| Control (Gate) Voltage, VDD = 0 VDC | 15 | V |
| Output Device Channel Temperature | +200 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature Range | -20 to |  |
| +90 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range | -40 to <br> +100 | ${ }^{\circ} \mathrm{C}$ |
| Operation of this device beyond any one of these limits may cause per- <br> manent damage. For reliable continuous operation see typical setup val- <br> ues specified in the table on page one. |  |  |

## Caution: ESD Sensitive

Appropriate precaution in handling, packaging and testing devices must be observed.

## Note 1:

Internal RF decoupling is included on all bias leads. No additional bypass elements are required, however some applications may require energy storage on the $\mathrm{V}_{\mathrm{D}}$ leads to accommodate modulated signals.

## Note 2:

Gate voltage must be applied to $\mathrm{V}_{\mathrm{GS}}$ leads simultaneously with or after application of drain voltage to prevent potentially destructive oscillations. Bias voltages should never be applied to a module unless it is properly terminated on both input and output.

## Note 3:

The required $\mathrm{V}_{\mathrm{GS}}$ corresponding to a specific $\mathrm{I}_{\mathrm{DQ}}$ will vary from module to module and may differ between $\mathrm{V}_{\mathrm{GS} 1}$ and $\mathrm{V}_{\mathrm{GS} 2}$ on the same module by as much as $\pm 0.10$ volts due to the normal die-to-die variation in threshold voltage for LDMOS transistors.

## Note 4:

The threshold voltage $\left(\mathrm{V}_{\text {GSTH }}\right)$ of LDMOS transistors varies with device temperature. External temperature compensation may be required. See Sirenza application notes AN-067 LDMOS Bias Temperature Compensation.

## Note 5:

This module was designed to have it's leads hand soldered to an adjacent PCB. The maximum soldering iron tip temperature should not exceed $700^{\circ} \mathrm{C}$, and the soldering iron tip should not be in direct contact with the lead for longer than 10 seconds. Refer to app note AN054 (www.sirenza.com) for further installation instructions.

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EDS-104211 Rev D

## Typical Performance Curves



CW Gain, Efficiency, IRL vs Frequency Vdd=28V, Idq=0.6A,



http://www.sirenza.com EDS-104211 Rev D

## Typical Performance Curves (cont'd)





Note:
Evaluation test fixture information available on Sirenza Website, referred to as SDM-EVAL.

SDM-09060-B1F 925-960 MHz 65W Power Amp Module

## Package Outline Drawing





MODULE WEIGHT $=43 \mathrm{gm}$ NOMINAL

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NOTES: UNLESS OTHERWISE SPECIFIED
1. INTERPRET DRAWING PER ANSI Y14.5.
2. MEASURE FROM THE BOTTON OF THE LEADS.
3. DIMENSIONS ARE INCHES[MM].
4. LEAD DENTIFICATION IS FOR REFERENCE ONLY
5 ORIENTATION OF LABEL IS to be AS Shom
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Note:
Refer to Application note AN054, "Detailed Installation Instructions for Power Modules" for detailed mounting information.

